

GA-686N is an advanced halogen-free high Tg (190 °C/DSC) ultra low-loss multifunctional epoxy laminate. Superior electrical performance are suitable for high frequency high speed telecommunications. The characteristics of low transmission loss and low degree of distortion can be mainly suitable for base station platform, cloud computing, storage and advanced servers.

Key Features

宏仁企業集團 GRACE T.H.W. GROUP

● Tg: 190 ℃(DSC)

This material with high performance multi-function resin , crosslink density is high. Material Tg values can reach above 190 C(DSC).

Dk: 3.50 & *Df:* 0.0023 Material has superior electrical properties, is conducive to the high frequency high-speed transmission, and high density wiring design. The lower signal loss can ensure signal integrity.

• Z-CTE(50-260):2.2%

Its remarkable very low expansion coefficient, is more suitable for making high multilayer PCB, ensure the reliability of high temperature welding and assembly process.

• Td: 380 ${\mathcal C}$

Excellent resistance to aging temperature, keep the material performance in high thermal shock or high temperature environment impact.

Normal Size & Thickness

Thickness Size Thickness Tolerance Inch (mm) Inch mm 0.002 (0.05) 49×37 1244×0940 IPC-4101 Class C/M То 49×41 1244×1042 0.125 (3.2) 49×43 1244×1093

Laminate:GA-686N Prepreg: GA-686BN

Applications

- > Multilayer PCB
- > Servers
- > Storage
- > Router/Switch
- > RF/Wireless Communication
- Line cards

Industrial Approvals

- ➢ UL File Number ∶ e186152
- ➢ Flammability Rating ∶ 94V-0

Characteristic		Unit	Test Method	Typical data	spec
GA-686N			IPC-TM-650 (or as noted)		
Volume Resistivity		MΩ-cm	2.5.17.1	2X10 ⁹	$\ge 10^6$
Surface Resistivity		MΩ	2.5.17.1	1X10 ⁸	$\ge 10^5$
Permittivity (RC50%)	At 1GHz		2.5.5.13	3.50	/
	At 5GHz		2.5.5.13	3.40	/
	At 10GHz		2.5.5.13	3.40	/
	At 15GHz		2.5.5.13	3.40	/
Loss Tangent (RC50%)	At 1GHz		2.5.5.13	0.0023	/
	At 5GHz		2.5.5.13	0.0026	/
	At 10GHz		2.5.5.13	0.0030	/
	At 15GHz		2.5.5.13	0.0034	/
Arc Resistance		Sec	2.5.1	120	≧60
Dielectric Breakdown		KV	2.5.6	40	≧40
Electric Strength(thickness<0.5mm)		KV/mm	2.5.6.2	40	≧30
Thermal Stress Test		-	2.4.13.1	Pass	Pass
Td (5% Weight loss)		°C	2.4.24.6	380	≧340
Glass Transition	DMA	°C	2.4.24.4	210	/
Temperature	DSC	°C	2.4.25	190	≧185
T288		Min	2.4.24.1	≧60	≧15
Т300		Min	2.4.24.1	≧60	≧2
Z-Axis CTE	Before Tg	PPM/℃	2.4.24	40	≦45
	After Tg	PPM/°C		240	≦260
Z-Axis CTE (50~260℃)		%	2.4.24	2.2	≦2.8
Peel Strength (10Z)		Lb/in(N/mm)	2.4.8	4.5(0.78)	≧4(0.7)
Flexural Strength	LW	N/mm ²	2.4.4	410	≧345
	CW	N/mm ²		350	≧345
Moisture Absorption		%	2.6.2.1	0.07	≦0.2
Flammability		-	UL94	V-0	V-0

Note: 1.Test sample is 62mil 1/1(without special remark).

2. The data above is only for reference, and the actual data will have deviation, according to varieties of test equipment and method.